PATENTS ORDINANCE (Chapter 514)

NOTICE OF SPECIFICATION OF FORMS

Pursuant to section 150 of the Patents Ordinance (Chapter 514) (the "Ordinance"), notice is hereby given that the forms specified below and attached to this notice shall, with effect from 17 July 2020, be used in connection with the proceedings described below:-

Description of Proceedings	Form no.	Fee no.
Request to record a designated patent application for a standard patent (R) under sections 15, 16, 22 of the Ordinance and sections 8, 18 of the Patents (General) Rules	<u>P4</u>	4, 7, 9
Request for grant of a short-term patent under sections 113, 116, 125 of the Ordinance and sections 58, 74 of the Patents (General) Rules	<u>P6</u>	6, 8, 10

During the transitional period from 17 July 2020 to 17 January 2021 (the "Transitional Period"), Forms P4 and P6 as specified in the Notice of Specification of Forms published in the Hong Kong Intellectual Property Journal on 13 December 2019 (the "<u>Previous Notice</u>") may continue to be used in connection with the proceedings described therein.

This notice shall, upon the expiry of the Transitional Period, supersede the Previous Notice (to the extent applicable) in relation to Forms P4 and P6.

For the avoidance of doubt, the Chinese version of Forms P4 and P6 as specified in <u>the Chinese</u> version of the Previous Notice may continue to be used in connection with the proceedings described therein and shall not be affected by this notice.

10 July 2020

David WONG Registrar of Patents



Patents Form P4

Request to record a designated patent application for a standard patent (R)

Patents Ordinance (Cap. 514)

Patents (General) Rules (Cap. 514C)

Important notes

1. General notes:

- a. This form is available in Chinese and English. Either Chinese or English can be used as the language of proceedings. Please complete this form in English unless otherwise stated. The language of proceedings will be in English.
- b. By submitting this form, you will be treated as having given consent to the Patents Registry and its service provider to copy or communicate all the information provided to any third party (in or outside Hong Kong) who assists or supports the Patents Registry in performing its functions under the Patents Ordinance, Cap. 514 and its subsidiary legislation.
- c. This form must be signed and dated.
- d. If there is not enough space for any part on this form, please continue on an additional sheet. Number each additional sheet and state the number of additional sheet(s) in Part 11(a).
- e. Please enquire through the following means:
 - E-mail: enquiry@ipd.gov.hk
 - Internet homepage address: <u>www.ipd.gov.hk</u>
- f. The Patents Ordinance, Cap 514 and Patents (General) Rules, Cap 514C can be viewed at www.ipd.gov.hk.

2. Use of personal data:

Personal data collected by the Registrar of Patents ("the Registrar") in the forms filed with the Registrar will be used for the purposes set out in the Personal Information Collection Statement at https://www.ipd.gov.hk/eng/personal_information.htm.

3. Use of other information:

- a. The Patents Registry will use any information relating to any commercial enterprise or entity provided in this form and any document(s) filed in relation to it for processing your application, request or notice, and for the purposes of collection set out in the Personal Information Collection Statement at <u>https://www.ipd.gov.hk/eng/personal information.htm</u>. They may be made available for public inspection, in full or in part, pursuant to section 147 of the Patents Ordinance, Cap. 514. Such information may be accessed through the Internet.
- b. DO NOT include any business information of your own or that of third parties which you consider to be confidential or commercially sensitive. Where such information is included in this form or any document(s) filed in relation to it, the Registrar will treat it an express and voluntary consent given by you and any such third party to disclosure of all such information for the purpose of public inspection.

4. Submission of application/request/notice:

- a. In person or by mail with the appropriate fee to the Registrar of Patents, 24/F, Wu Chung House, No. 213 Queen's Road East, Wanchai, Hong Kong. The fee schedule can be viewed at <u>www.ipd.gov.hk/eng/forms_fees.htm</u>. Payment can be made in person by cash, or by sending a cheque/bank draft (in Hong Kong dollars which can be cleared in Hong Kong) made payable to THE GOVERNMENT OF THE HONG KONG SPECIAL ADMINISTRATIVE REGION.
- b. This form can also be submitted electronically. For details, please visit IPD's e-Filing System.

5. Abbreviation:

The abbreviation "CNIPA" in Part 06(f) stands for the "National Intellectual Property Administration, People's Republic of China" which was formerly known as the "State Intellectual Property Office, People's Republic of China".

01. Reference

Filer's reference

02. Details of applicant(s)

If there is more than one applicant, please provide details of <u>all</u> applicants.

(a) Name in English If your name is not in Roman letters or in Chinese, please include a transliteration in Roman letters.	
(b) Name in Chinese (if applicable)	
(c) Address	Flat/Floor/Building
	Street/District/City
	Country/Territory/Area
(d) Applicant type Please mark <u>one</u> box only.	Individual Go to Part 03
	Incorporated Go to Part 02(e) (and Part 02(f) if applicable) Unincorporated Go to Part 03
(e) Country/Territory/Area of incorporation	
(f) State of incorporation For applicant incorporated in the United States.	
Statement of entitlement to ap	olv

Go to Part 04 if the applicant is the person named as the applicant in the designated patent application.

If the applicant is NOT the person named as the applicant in the designated patent application, please mark the following box(es) for providing a **statement** explaining the applicant's entitlement to apply for the grant of a standard patent (R) for the invention and submit the **prescribed documents** supporting the statement. (Section 15(2)(d), Patents Ordinance and section 9, Patents (General) Rules)

Statement Please mark the appropriate box(es).	_	By virtue of assignment By virtue of merger
		Others (please specify)

04. Title of invention

You must state the title of the invention in both English and Chinese.

(a) English

	(b) Chinese	
05.	Details of designated patent app	lication
	(a) Application no.	
	(b) Filing date	DD-MM-YYYY
	(c) Designated patent office Please mark <u>one</u> box only.	□ сn / □ ер(GB) / □ GB
	(d) Publication no. (if any)	Example: 16102178
	(e) Publication date (if any)	DD-MM-YYYY

06. Details of international application

Go to Part 07 if the designated patent application is NOT based on an international application.

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If the designated patent application is based on an international application, please provide the following details. (Section 16, Patents Ordinance and section 15, Patents (General) Rules)

(e)	Date of pu	ublication	in the
	designated	patent	office
	indicating	that	the
	internationa		ion has
	validly ente	red the	national
	phase		
	(if different from	the publication	on date in

(if different from the publication date in Part 05(e))

or

details.

(a) Type

(f) Date of issuance of the official notification by the CNIPA stating that the international application has entered the national phase in that office

07. Details of earlier application

D-MM-YYYY

DD-MM-YYYY

If the application is divided or derived from an earlier Hong Kong application, please provide the following

Divisional application (section 22, Patents

Go to Part 08 if you do NOT claim the filing date of an earlier application.

Ordinance)

New application filed on court order upon determination of right to patent after grant (section 55, Patents Ordinance)

(b) Earlier application no.

Please mark one box only.

(c) Earlier application filing date

(d) Publication date of the request to record of the earlier application

DD-MM-YYYY

DD-MM-YYYY

08. Statement of details of priority claim (please do not submit the priority document)

Go to Part 09 if you do NOT claim priority.

Where **a claim of priority** under section 11B, Patents Ordinance is made, please provide a statement of the following details. (Section 15(2)(e), Patents Ordinance)

	Country/Territory/Area	Priority application no.	Priority application filing date
1.			DD-MM-YYYY
2.			DD-MM-YYYY
3.			DD-MM-YYYY
4.			DD-MM-YYYY

			Τ.
5.		DD-MM-YYYY	
•			
6		DD-MM-YYYY	-
6.			
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09. Statement of inventorship

Go to Part 10 if the designated patent application contains the inventor's name.

If the designated patent application does NOT contain the inventor's name, please provide a statement identifying the person(s) the applicant believes to be the inventor(s).

If the name of the inventor is not in Roman letters or in Chinese, please include a transliteration in Roman letters.

	Name in English	Name in Chinese (if applicable)
1.		
2.		
3.		
4.		
5.		
6.		•

10. Statement of non-prejudicial disclosure

Go to Part 11 if you do NOT claim non-prejudicial disclosure.

Where a claim of non-prejudicial disclosure is made, please provide a statement indicating the following details relating to the previous disclosure. (Section 15(2)(f), Patents Ordinance and section 10, Patents (General) Rules)

(a) Name of the exhibition or meeting	
(b) Place of the exhibition or meeting	
(c) Opening date of the exhibition or meeting	DD-MM-YYYY
(d) Date of first disclosure (if the first disclosure did not take place on the opening date of such exhibition or meeting)	DD-MM-YYYY

11. List of documents

Please enter the no. of sheets of attached document(s), if any, in the following box(es).

(a) Additional sheet(s) attached to this form	sheet(s)
(b) Copy of the designated patent application as published	sheet(s)
(c) In the case of an international application, copy of:	
(i) the international application as published by the International Bureau	sheet(s)
(ii) translation of the international application published by the designated patent office	sheet(s)
(iii) publication of information in the designated patent office concerning the international application	sheet(s)
(d) Translation of abstract	sheet(s)
(e) The prescribed documents supporting the statement of entitlement to apply mentioned in Part 03 and its translation into the language of the proceedings if it is not in one of the official languages	sheet(s)
(f) Others (please specify)	sheet(s)

12. Address for service

All correspondence and/or document(s) will be sent to the address below.

(a) Name

(b) Address

You must provide an address for service in <u>Hong Kong</u>. Please note that a P.O. Box or "care of" address is not acceptable.

Flat/Floor/Building

Street/District

HONG KONG

(c) Telephone no. In Hong Kong

(d) Fax no. In Hong Kong

13. Agent's details

Go to Part 14 if you are NOT an agent.

Please complete this part if you have been duly authorized to act as an agent on behalf of the applicant(s) for the purpose of this request.

(a) Name

(b) Address

You must provide an address in <u>Hong</u> <u>Kong</u> where you reside or carry on your business activities. Please note that a P.O. Box or "care of" address is not acceptable. Flat/Floor/Building

Street/District

HONG KONG

14. Signature

I/We confirm that I/we have read and understood the "Important notes" of this form.

(a) Authorized signature

- (b) Name of signatory
- (c) Official capacity of signatory Examples: Authorized person, Director, Partner or Principal Officer of Applicant(s)/Agent; Applicant in person

(d) Date

DD-MM-YYYY



Patents Form P6

Request for grant of a short-term patent

Patents Ordinance (Cap. 514) Patents (General) Rules (Cap. 514C)

Important notes

1. General notes:

- a. This form is available in Chinese and English. Either Chinese or English can be used as the language of proceedings. Please complete this form in English unless otherwise stated. The specification must be in English.
- b. By submitting this form, you will be treated as having given consent to the Patents Registry and its service provider to copy or communicate all the information provided to any third party (in or outside Hong Kong) who assists or supports the Patents Registry in performing its functions under the Patents Ordinance, Cap. 514 and its subsidiary legislation.
- c. This form must be signed and dated.
- d. If there is not enough space for any part on this form, please continue on an additional sheet. Number each additional sheet and state the number of additional sheet(s) in Part 13(a).
- e. Please enquire through the following means:
 - E-mail: enquiry@ipd.gov.hk
 - Internet homepage address: www.ipd.gov.hk
- f. The Patents Ordinance, Cap. 514 and Patents (General) Rules, Cap. 514C can be viewed at www.ipd.gov.hk.

2. Use of personal data:

Personal data collected by the Registrar of Patents ("the Registrar") in the forms filed with the Registrar will be used for the purposes set out in the Personal Information Collection Statement at <u>https://www.ipd.gov.hk/eng/personal_information.htm</u>.

3. Use of other information:

- a. The Patents Registry will use any information relating to any commercial enterprise or entity provided in this form and any document(s) filed in relation to it for processing your application, request or notice, and for the purposes of collection set out in the Personal Information Collection Statement at https://www.ipd.gov.hk/eng/personal information.htm. They may be made available for public inspection, in full or in part, pursuant to section 147 of the Patents Ordinance, Cap. 514. Such information may be accessed through the Internet.
- b. **DO NOT include any business information of your own or that of third parties which you consider to be confidential or commercially sensitive.** Where such information is included in this form or any document(s) filed in relation to it, the Registrar will treat it an express and voluntary consent given by you and any such third party to disclosure of all such information for the purpose of public inspection.

4. Submission of application/request/notice:

- a. In person or by mail with the appropriate fee to the Registrar of Patents, 24/F, Wu Chung House, No. 213 Queen's Road East, Wanchai, Hong Kong. The fee schedule can be viewed at <u>http://www.ipd.gov.hk/eng/forms_fees.htm</u>. Payment can be made in person by cash, or by sending a cheque/bank draft (in Hong Kong dollars which can be cleared in Hong Kong) made payable to THE GOVERNMENT OF THE HONG KONG SPECIAL ADMINISTRATIVE REGION.
- b. This form can also be submitted electronically. For details, please visit IPD's e-Filing System.

5. Abbreviation:

The abbreviation "CNIPA" in Parts 06(e) and 13(j)(iii) & (iv) stands for the "National Intellectual Property Administration, People's Republic of China" which was formerly known as the "State Intellectual Property Office, People's Republic of China".

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01. Reference

Filer's reference

02. Details of applicant(s)

If there is more than one applicant, please provide details of <u>all</u> applicants.

(a) Name in English If your name is not in Roman letters or in Chinese, please include a transliteration in Roman letters.	
(b) Name in Chinese (if applicable)	
(c) Address	Flat/Floor/Building
	Street/District/City
	Country/Territory/Area
(d) Applicant type	Individual Go to Part 03
Please mark <u>one</u> box only.	Incorporated Go to Part 02(e) (and Part 02(f) if applicable)
	Unincorporated Go to Part 03
(e) Country/Territory/Area of incorporation	
(f) State of incorporation For applicant incorporated in the United States.	

03. Title of invention

You must state the title of the invention in **both** English and Chinese.

(a) English

(b) Chinese

The number of independent claim(s) must not exceed two. (Section 113(1A)(b)(ii), Patents Ordinance)

Number of independent claim(s) pr	rovided in the specification
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05. Use of micro-organisms

Go to Part 06 if the invention does NOT require the use of a micro-organism for its performance.

If the invention requires the use of a micro-organism for its performance, please mark the appropriate box(es). (Section 73 and Schedule 1, Patents (General) Rules)

(a)	availa	ble to	micro-organism the public at the of the application;	🗌 Yes	
(b)	descri the sp in suc the inv	bed in ecifica h a ma vention	micro-organism the application or tion of the patent nner as to enable to be performed skilled in the art.	Yes	□ No

(c) If you have marked "No" in both boxes in (a) and (b), please provide the following details:

(i) Name of the depositary institution	
(ii) Address of the depositary institution	
(iii) Date of deposit	DD-MM-YYYY
(iv) Accession no. of the deposit	

06. Details of international application

Go to Part 07 if the short-term patent application is NOT based on an international application.

If the short-term patent application is based on an international application, please provide the following details. (Section 125, Patents Ordinance and section 78, Patents (General) Rules)

(a) International application no.	
(b) International filing date	DD-MM-YYYY
(c) International publication no.	

(d) International publication date	DD-MM-YYYY
(e) Date of entry into the national phase in the People's Republic of China	DD-MM-YYYY
or	
Date of issuance of an official notification by the CNIPA as prescribed under section 78 of the Patents (General) Rules	DD-MM-YYYY
(f) Application no. of the Chinese patent application (if known)	

07. Statement of reference to an earlier specified application

Go to Part 08 if you do NOT make reference to an earlier specified application.

If a reference to an earlier specified application under section 114(3)(c)(ii), Patents Ordinance is made, please provide a statement by marking the box below and provide the following details. (Sections 58(5)(i) and 67A, Patents (General) Rules).

I/We confirm that a description and the drawings (if any) of the invention, which is the subject of the short-term patent application, are completely contained in the following earlier specified application:

Country/Territory/Area	Earlier specified application no.	Earlier specified application filing date
		DD-MM-YYYY
	ł	

08. Details of earlier application

Go to Part 09 if you do NOT claim the filing date of an earlier application.

If the application is divided or derived from an earlier Hong Kong application, please provide the following details.

(a) Type Please mark <u>one</u> box only.		Divisional application (section 116, Patents Ordinance)
		New application filed on court order upon determination of right to patent after grant (section 55, Patents Ordinance)
(b) Earlier application no.		
(c) Earlier application filing date	DD-MM-YY	YY

09. Statement of priority claim

Go to Part 10 if you do NOT claim priority.

If a claim of priority under section 111, Patents Ordinance is made, please provide a statement of the following details. (Sections 58(5)(c), 69, Patents (General) Rules)

	Country/Territory/Area	Priority application no.	Priority application filing date
1.			DD-MM-YYYY
2.			DD-MM-YYYY
2.			
3.			DD-MM-YYYY

10. Name(s) of inventor(s) (inventor must be individual not company)

If the applicant(s) is/are not the inventor(s), a statement identifying the inventor(s) and indicating how the applicant(s) become(s) entitled to apply for a short-term patent for the invention must be made on Form P6A. (Section 113(2)(c), Patents Ordinance and section 65, Patents (General) Rules)

If the name of the inventor is not in Roman letters or in Chinese, please include a transliteration in Roman letters.

	Name in English	Name in Chinese (if applicable)
1.		
2.		
3.		
4.		
5.		

11. Statement of non-prejudicial disclosure

Go to Part 12 if you do NOT claim non-prejudicial disclosure.

If the applicant is making a claim regarding non-prejudicial disclosure under section 109, Patents Ordinance, please provide a statement giving details relating to such disclosure and provide written evidence in support of that statement. (Section 109, Patents Ordinance and sections 58(5)(f), 70, Patents (General) Rules)

(a) Statement

(b) Name of the exhibition	
(c) Place of the exhibition	
(d) Opening date of the exhibition	DD-MM-YYYY
(e) Date of first disclosure (if the first disclosure did not take place on the opening date of such exhibition)	DD-MM-YYYY
12. Deferral of Grant	

Go to Part 13 if you do NOT request deferral of grant.

If a request for deferral of grant under section 119, Patents Ordinance is required, please enter the period of such deferral.

Deferral of grant up to (The period of deferral should not exceed 12 months)	DD-MM-YYYY
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13. List of documents

Please enter the no. of sheets of attached document(s), if any, in the following box(es).

(a) Additional sheet(s) attached to this form	sheet(s)
(b) Description	sheet(s)
(c) Claim(s)	sheet(s)
(d) Drawing(s)	sheet(s)
(e) Abstract (in both English and Chinese)	sheet(s)
(f) Priority document(s)	sheet(s)
(g) Translation of the priority document(s) (if the previous application is not in one of the official languages)	sheet(s)
(h) Search report	sheet(s)
(i) Translation of the search report (if not in one of the official languages)	sheet(s)
(j) In the case of an international application, copy of:	
(i) the international application as published by the International Bureau	sheet(s)

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(ii) the international search report	sheet(s)
(iii) translation of the international application as published by the CNIPA	sheet(s)
(iv) information as published by the CNIPA concerning the international application	sheet(s)
(k) Statement of inventorship on Form P6A	sheet(s)
(I) Sequence listing if the invention involves nucleotide and amino acid sequences	sheet(s)
(Sequence listing may be filed in electronic form even if the short-term patent application is not filed by way of electronic filing.)	
(m) Others (please specify)	sheet(s)

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14. Address for service

All correspondence and/or document(s) will be sent to the address below.

(a) Name

(b) Address

You must provide an address for service in <u>Hong Kong</u>. Please note that a P.O. Box or "care of" address is not acceptable.

Flat/Floor/Building

Street/District

HONG KONG

(c) Telephone no.

In Hong Kong

(d) Fax no.

In Hong Kong

15. Agent's details

Go to Part 16 if you are NOT an agent.

Please complete this part if you have been duly authorized to act as an agent on behalf of the Applicant(s) for the purpose of this request.

(a) Name

(b) Address

You must provide an address in <u>Hong</u> <u>Kong</u> where you reside or carry on your business activities. Please note that a P.O. Box or "care of" address is not acceptable. Flat/Floor/Building

Street/District

HONG KONG

16. Signature

I/We confirm that I/we have read and understood the "Important notes" of this form.

 (a) Authorized signature

 (b) Name of signatory

 (c) Official capacity of signatory

 Examples: Authorized person,

 Director, Partner or Principal Officer of

 Applicant(s)/Agent; Applicant in person

 (d) Date